

- operating up to 450MHz, and for analog switching requiring low capacitance.
- Sourced from process 50.



2N3819

1. Drain 2. Gate 3. Source

Epitaxial Silicon Transistor

Absolute Maximum Ratings* $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I _D	Drain Current	50	mA
I _{GF}	Forward Gate Current	10	mA
T _{STG}	Storage Temperature Range	-55 ~ 150	°C

* This ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

These rating are based on a maximum junction temperature of 150 degrees C.
These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

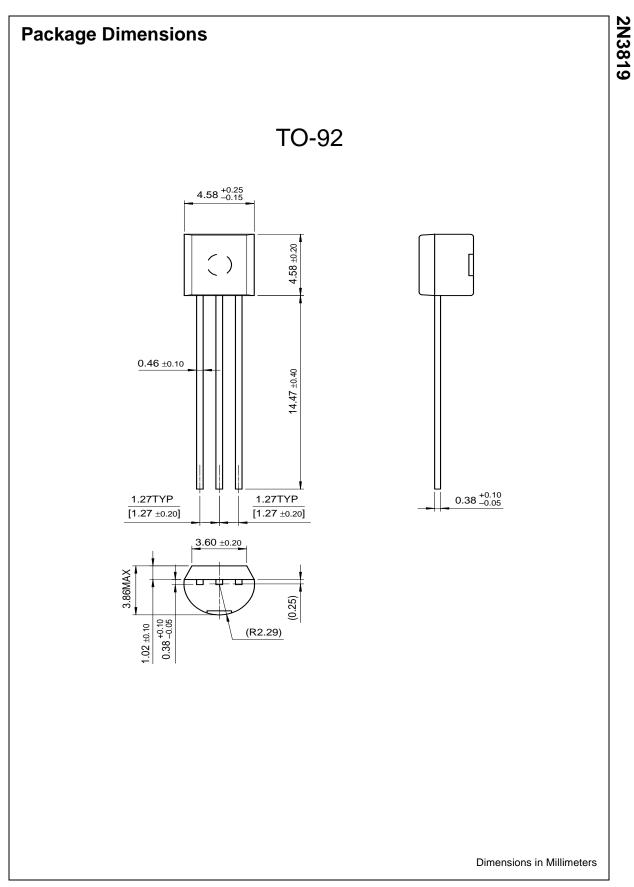
Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	teristics					
V _{(BR)GSS}	Gate-Source Breakdwon Voltage	$I_{G} = 1.0 \mu A, V_{DS} = 0$	25			V
I _{GSS}	Gate Reverse Current	$V_{GS} = -15V, V_{DS} = 0$			2.0	nA
V _{GS} (off)	Gate-Source Cutoff Voltage	$V_{DS} = 15V, I_{D} = 2.0nA$			8.0	V
V _{GS}	Gate-Source Voltage	$V_{DS} = 15V, I_{D} = 200\mu A$	-0.5		-7.5	V
On Charac	teristics				•	•
I _{DSS}	Zero-Gate Voltage Drain Current	$V_{DS} = 15V, V_{GS} = 0$	2.0		20	mA
Small Sigr	al Characteristics				•	•
gfs	Forward Transfer Conductance	V _{DS} = 15V, V _{GS} = 0, f = 1.0KHz 2000			6500	μmhos
goss	Output Conductance	V _{DS} = 15V, V _{GS} = 0, f = 1.0KHz			50	μmhos
y _{fs}	Forward Transfer Admittance	V _{DS} = 15V, V _{GS} = 0, f = 1.0KHz	1600			μmhos
C _{iss}	Input Capacitance	V _{DS} = 15V, V _{GS} = 0, f = 1.0KHz			8.0	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 15V, V _{GS} = 0, f = 1.0KHz			4.0	pF

Thermal Characteristics $T_A=25^{\circ}C$ unless otherwise noted

Parameter	Max.	Units
Total Device Dissipation	350	mW
Derate above 25°C	2.8	mW/°C
Thermal Resistance, Junction to Case	125	°C/W
Thermal Resistance, Junction to Ambient	357	°C/W
	Total Device Dissipation Derate above 25°C Thermal Resistance, Junction to Case	Total Device Dissipation350Derate above 25°C2.8Thermal Resistance, Junction to Case125

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